

SEA & LAND ELECTRONIC CORP.

WWW.SEALAND-PPTC.COM

ALPHA-TOP TECHNOLOGY CORP.

WWW.ALPHA-TOP.CN

#### APPROVAL SHEET

MODEL NO.: mSMD300-24V

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:

HEAD OFFICE:

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Submitted by: Chen
Approved by: YC Lin
DATE: 20-May-24

SEA & LAND ELECTRONIC CORP.



## mSMD300-24V

- Surface Mount Devices
- Lead free device
- Size 4.5\*3.2 mm/0.18\*0.12 inch
- Surface Mount packaging for automated assembly

Almost anywhere there is a low voltage power supply, up to 60V and a load to be

protected, including:

- Computer mother board, Modem. USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

**Performance Specification** 

						Maxi	mum	Resis	tance		
Model	$V_{max}$	I <sub>max</sub>	I <sub>hold</sub>	I <sub>trip</sub>	$P_d$	Time 1	To Trip			Agency	Approval
Wodel			@25°C	@25°C	Тур.	Current	Time	$Ri_{min}$	R1 <sub>max</sub>	UL	TUV
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	$(\Omega)$	(Ω)	OL	100
mSMD300-24V	24	100	3.00	5.00	0.8	8.0	4.00	0.012	0.040		√

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1<sub>max</sub> = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

	0H/K 0910
Environmental Specifications	C 1/3/1/3
Test	Conditions
Passive aging	+85°C, 1000 hrs.
Humidity aging	+85°C, 85% R.H., 168 hours
Thermal shock	+85°C to -40°C, 20 times
Resistance to solvent	MIL-STD-202,Method 215
Vibration	MIL-STD-202,Method 201
Ambient operating conditions : - 40 °C to +85 °C	·
Maximum surface temperature of the device in the tripped sta	ate is 125 °C
In case of special use,please contact our engineer	<u> </u>

#### Agency Approvals:

R 50481056

Regulation/Standard:

2015/863/EU

EN14582

#### I<sub>bold</sub> Versus Temperature

noid									
Model	Maximum an	nbient operatii	ng temperatur	re (T <sub>mao</sub> ) vs. h	old current (I <sub>h</sub>	nold)			
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
mSMD300-24V	4 15	3.76	3 46	3 00	2 55	2 28	2 01	1 61	1 33

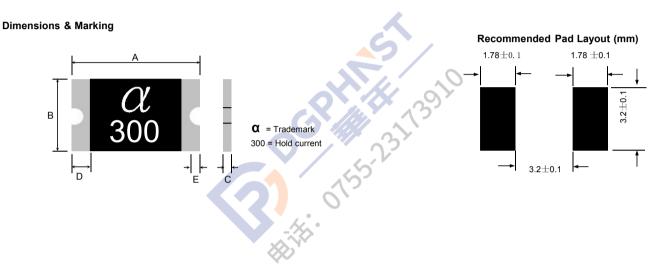


### mSMD300-24V

Alpha-Top (Sea & Land Alliance)

Construction And Dimension (Unit:mm)

Model	A		В		С		D	E	
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	
mSMD300-24V	4.37	4.73	3.07	3.41	0.90	1.80	0.30	0.25	



#### **Termination Pad Characteristics**

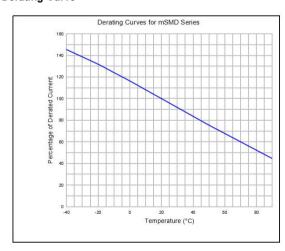
Terminal pad materials : Tin-plated Nickel-Copper

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

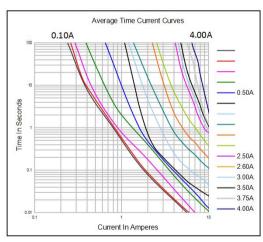
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

#### Thermal Derating Curve



#### Typical Time-To-Trip At 25°C



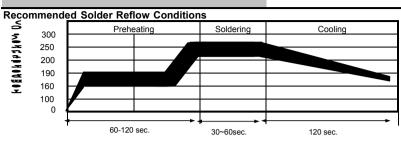
# WARNING:

- · Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
  · PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are
- · Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

  · Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.



## mSMD300-24V



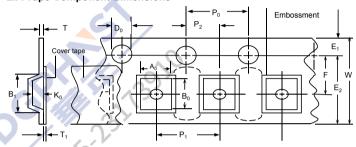
- · Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- · Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

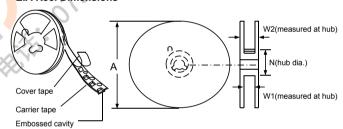
#### Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	12 ± 0.3
P0	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
A0	3.5 ± 0.23
B0	5.1 ± 0.15
B1max.	5.9
D0	1.5 + 0.1, -0
F	5.5 ± 0.05
<u>E1</u>	1.75 ± 0.10
E2min.	10.25
Tmax.	0.6
T1max.	0.1
K0	0.9 ± 0.15
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	12.4 + 2.0, -0.0
W2max.	18.4

#### **EIA Tape Component Dimensions**



#### **EIA Reel Dimensions**



#### Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

# Order Information Packaging mSMD 300-24V Tape & Reel Quantity Product name Hold

Product name

Size 4532mm/1812 inch

SMD : surface mount device

Hold

Current

1,500 pcs/reel

3.00A

Tape & reel packaging per EIA481-1

#### Labeling Information

